

PNP Low-Saturation Transistor

NZT660, NZT660A

Description

These devices are designed with high-current gain and low saturation voltage with collector currents up to 3 A continuous.

ABSOLUTE MAXIMUM RATINGS

 $(T_A = 25 \, ^{\circ}C \text{ unless otherwise noted.}) \, (Notes 1, 2)$

Symbol	Parameter	Value	Unit
V _{CEO}	Collector-Emitter Voltage	-60	V
V _{CBO}	Collector-Base Voltage NZT660 NZT660A	-80 -60	V
V _{EBO}	Emitter-Base Voltage	-5	V
I _C	Collector Current - Continuous	-3	Α
T _J , T _{STG}	Operating and Storage Junction Temperature Range	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

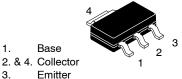
- 1. These ratings are based on a maximum junction temperature of 150 °C.
- These are steady limits. onsemi should be consulted on application involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS

(T_A = 25 °C unless otherwise noted.) (Note 3)

Symbol	Parameter	Max	Unit
P_{D}	Total Device Dissipation	2	W
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient	62.5	°C/W

3. PCB size: FR-4, 76 mm \times 114 mm \times 1.57 mm (3.0 inch \times 4.5 inch \times 0.062 inch) with minimum land pattern size.



SOT-223 CASE 318H

MARKING DIAGRAM



= Assembly Location

Y = Year W = Work Week

Α

660(A) = Specific Device Code ■ Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
NZT660	SOT-223 (Pb-Free)	4,000 / Tape & Reel
NZT660A	SOT-223 (Pb-Free)	4,000 / Tape & Reel

† For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

NZT660, NZT660A

ELECTRICAL CHARACTERISTICS ($T_C = 25$ °C unless otherwise noted.)

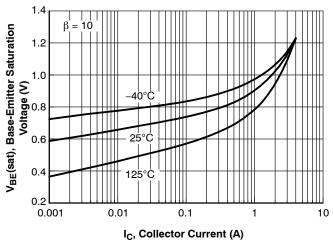
Symbol	Parameter	Test Conditi	ons	Min	Max	Unit
BV _{CEO}	Collector-Emitter Breakdown Voltage	I _C = -10 mA		-60	-	V
BV _{CBO}	Collector-Base Breakdown Voltage	I _C = -100 μA	NZT660	-80	-	٧
			NZT660A	-60	-	
BV _{EBO}	Emitter-Base Breakdown Voltage	I _E = -100 μA	•	- 5	-	V
I _{CBO}	Collector-Base Cut-Off Current	$V_{CB} = -30 \text{ V}$ $V_{CB} = -30 \text{ V}, T_A = 100 \text{ °C}$		-	-100	nA
				-	-10	μΑ
I _{EBO}	Emitter-Base Cut-Off Current	V _{EB} = -4 V		-	-100	nA
h _{FE}	DC Current Gain (Note 4)	I _C = -100 mA, V _{CE} = -2 V		70	-	
		$I_C = -500 \text{ mA},$ $V_{CE} = -2 \text{ V}$	NZT660	100	300	
			NZT660A	250	550	
		$I_C = -1 \text{ A}, V_{CE} = -2 \text{ V}$ $I_C = -3 \text{ A}, V_{CE} = -2 \text{ V}$		80	-	
				25	-	
V _{CE} (sat)	Collector-Emitter Saturation Voltage (Note 4)	I _C = -1 A, I _B = -100 mV		-	-300	mV
		$I_C = -3 \text{ A}, I_B = -300 \text{ mV}$	NZT660	-	-550	
			NZT660A	-	-500	
V _{BE} (sat)	Base-Emitter Saturation Voltage (Note 4)	I _C = -1 A, I _B = -100 mV		-	-1.25	V
V _{BE} (on)	Base-Emitter On Voltage (Note 4)	I _C = -1 A, V _{CE} = -2 V		-	-1	٧
C _{ob}	Output Capacitance	$V_{CB} = -10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		-	45	pF
f _T	Transition Frequency	$I_C = -100 \text{ mA}, V_{CE} = -5 \text{ V}, f = 100 \text{ MHz}$		75	-	MHz

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse test: pulse width $\leq 300 \ \mu s$, duty cycle $\leq 2.0\%$.

NZT660, NZT660A

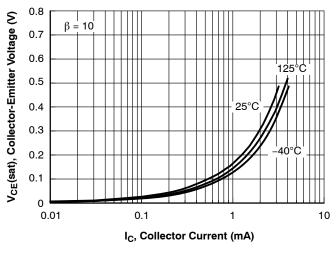
TYPICAL PERFORMANCE CHARACTERISTICS



1.6 V_{BE}(on), Base-Emitter ON Voltage (V) 1.4 1.2 1.0 ||||||| |-40°C 8.0 0.6 0.4 0.2 0.0001 0.001 0.01 0.1 1 10 I_C, Collector Current (A)

Figure 1. Base-Emitter Saturation Voltage vs.
Collector Current

Figure 2. Base-Emitter On Voltage vs. Collector Current



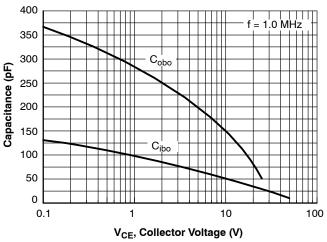


Figure 3. Collector-Emitter Saturation Voltage vs.
Collector Current

Figure 4. Input/Output Capacitance vs. Reverse Bias Voltage

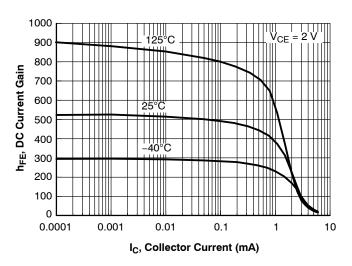


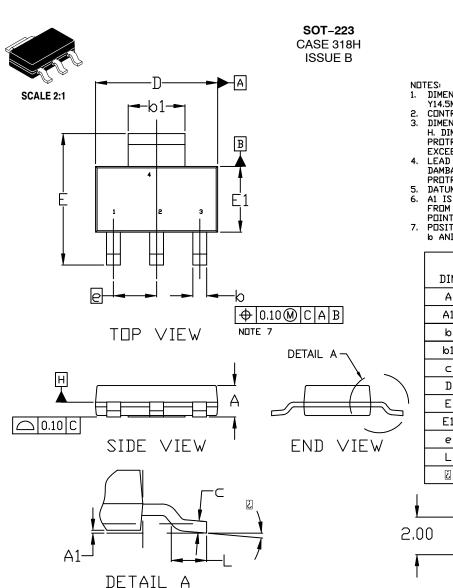
Figure 5. Current Gain vs. Collector Current

NZT660, NZT660A

REVISION HISTORY

Revision	Description of Changes	Date
3	Revision to correct marking diagram information only.	06/23/2025



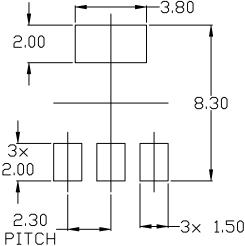


DATE 13 MAY 2020

- DIMENSIONING AND TOLERANCING PER ASME
- DIMENSIDNING AND TOLERANCING PER ASME Y14.5M, 2009.
 CONTROLLING DIMENSION: MILLIMETERS DIMENSIONS D & E1 ARE DETERMINED AT DATUM H. DIMENSIONS DO NOT INCLUDE MOLD FLASH, PROTRUSIONS DR GATE BURRS. SHALL NOT EXCEED 0.23mm PER SIDE.
 LEAD DIMENSIONS & AND &1 DO NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBBAR PROTRUSION. ALLOWABLE DAMBBAR PROTRUSION IS 0.08mm PER SIDE.
 DATUMS A AND B ARE DETERMINED AT DATUM H. A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
 POSITIONAL TOLERANCE APPLIES TO DIMENSIONS & AND &1.

- b AND b1.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α			1.80	
A1	0.02	0.06	0.11	
b	0.60	0.74	0.88	
b1	2.90	3.00	3.10	
С	0.24		0.35	
D	6.30	6.50	6.70	
E	6.70	7.00	7.30	
E1	3,30	3.50	3.70	
е	2.30 BSC			
L	0.25			
į.	0*		10°	



GENERIC MARKING DIAGRAM*



= Assembly Location Υ

= Year

W = Work Week

XXXXX = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the IIN Semiconductor Soldering and Mounting Techniques Reference Manual, SILDERRM/D.

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DESCRIPTION:	SOT-223		PAGE 1 OF 1	

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